

Radiation Hardened NPN Silicon Dual Transistor

2N2919_2N2920_L_U



Product Overview

Devices:

- 2N2919
- 2N2919L
- 2N2919U
- 2N2920
- 2N2920L
- 2N2920U

Qualified Levels:

- JANSE – 30K Rads (Si)¹
- JANSK – 50K Rads (Si)¹
- JANSU – 100K Rads (Si)¹
- JANSM – 3K Rads (Si)
- JANSD – 10K Rads (Si)
- JANSP – 30K Rads (Si)
- JANSL – 50K Rads (Si)
- JANSR – 100K Rads (Si)
- JANSF – 300K Rads (Si)

Note:

1. Low dose rate 10 mRad/s

Figure 1. TO-78



Figure 2. U-Package

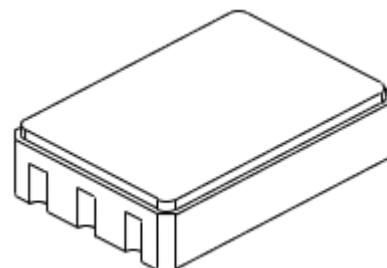


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1. Maximum Ratings

Table 1-1. Maximum Ratings at 25 °C Unless Otherwise Noted

Parameters / Test Conditions	Symbol	Value		Unit
Collector-Emitter voltage	V _{CEO}	60		Vdc
Collector-Base voltage	V _{CBO}	70		Vdc
Emitter-Base voltage	V _{EBO}	6.0		Vdc
Collector current	I _C	30		mAdc
Total power dissipation at T _A = +25 °C	P _T	One Section ¹ 200	Both Sections ² 350	mW
Operating and storage junction temperature range	T _J , T _{stg}	−65 to +200		°C

Notes:

1. Derate linearly 1.143 mW/°C for T_A > +25 °C (one section).
2. Derate linearly 2.000 mW/°C for T_A > +25 °C (both sections).

2. Electrical Characteristics

Table 2-1. Electrical Characteristics at 25 °C Unless Otherwise Stated

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Off Characteristics				
Collector-Emitter breakdown voltage $I_C = 10 \text{ mA}_\text{dc}$; pulsed	$V_{(\text{BR})\text{CEO}}$	60	—	Vdc
Collector-Base cutoff current $V_{CB} = 45 \text{ Vdc}$ $V_{CB} = 70 \text{ Vdc}$	I_{CBO}	—	2.0 10	nA_dc μA_dc
Emitter-Base cutoff current $V_{EB} = 5.0 \text{ Vdc}$ $V_{EB} = 6.0 \text{ Vdc}$	I_{EBO}	—	2.0 10	nA_dc μA_dc
On Characteristics				
Forward-Current transfer ratio $I_C = 10 \mu\text{A}_\text{dc}$, $V_{CE} = 5.0 \text{ Vdc}$ $I_C = 100 \mu\text{A}_\text{dc}$, $V_{CE} = 5.0 \text{ Vdc}$ $I_C = 1.0 \text{ mA}_\text{dc}$, $V_{CE} = 5.0 \text{ Vdc}$	h_{FE}	60 100 150	240 325 600	—
$I_C = 10 \mu\text{A}_\text{dc}$, $V_{CE} = 5.0 \text{ Vdc}$ $I_C = 100 \mu\text{A}_\text{dc}$, $V_{CE} = 5.0 \text{ Vdc}$ $I_C = 1.0 \text{ mA}_\text{dc}$, $V_{CE} = 5.0 \text{ Vdc}$	h_{FE}	175 235 300	600 800 1000	
Collector-Emitter saturation voltage $I_C = 1.0 \text{ mA}_\text{dc}$, $I_B = 100 \mu\text{A}_\text{dc}$	$V_{CE(\text{sat})}$	—	0.3	Vdc
Base-Emitter saturation voltage $I_C = 1.0 \text{ mA}_\text{dc}$, $I_B = 100 \mu\text{A}_\text{dc}$	$V_{BE(\text{sat})}$	0.5	1.0	Vdc

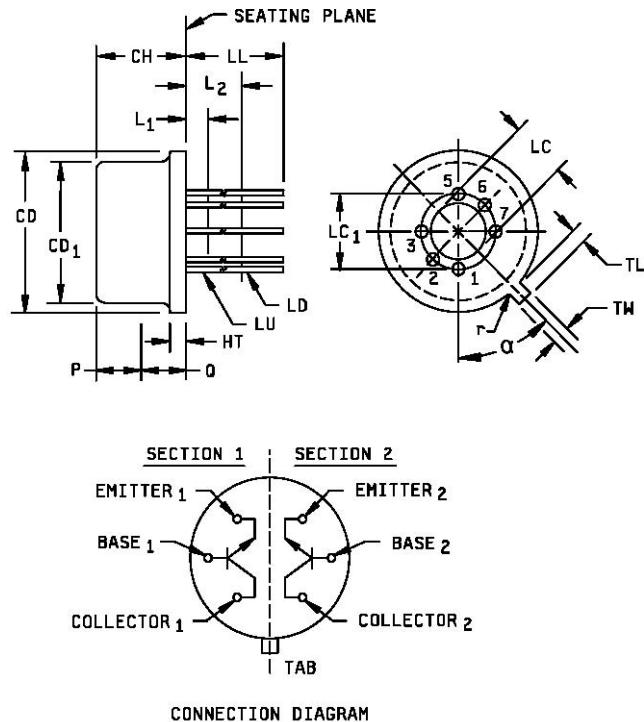
2.1 Dynamic Characteristics

Table 2-2. Dynamic Characteristics

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Forward current transfer ratio, magnitude $I_C = 0.5 \text{ mA}_\text{dc}$, $V_{CE} = 5.0 \text{ Vdc}$, $f = 20 \text{ MHz}$	$ h_{fe} $	3.0	20	—
Small-Signal short circuit input impedance $I_C = 1.0 \text{ mA}_\text{dc}$, $V_{CE} = 5 \text{ Vdc}$, $f = 1.0 \text{ kHz}$	h_{je}	3.0	30	kΩ
Small-Signal short circuit output admittance $I_C = 1.0 \text{ mA}_\text{dc}$, $V_{CE} = 5 \text{ Vdc}$, $f = 1.0 \text{ kHz}$	h_{oe}	—	60	μmhos
Output capacitance $V_{CB} = 5.0 \text{ Vdc}$, $I_E = 0$, $100 \text{ kHz} \leq f \leq 1.0 \text{ MHz}$	C_{obo}	—	5.0	pF
Noise figure $I_C = 10 \mu\text{A}_\text{dc}$, $V_{CE} = 5 \text{ Vdc}$, $f = 100 \text{ Hz}$, $R_G = 10 \text{ k}\Omega$ $I_C = 10 \mu\text{A}_\text{dc}$, $V_{CE} = 5 \text{ Vdc}$, $f = 1.0 \text{ kHz}$, $R_G = 10 \text{ k}\Omega$ $I_C = 10 \mu\text{A}_\text{dc}$, $V_{CE} = 5 \text{ Vdc}$, $f = 10 \text{ kHz}$, $R_G = 10 \text{ k}\Omega$	F_1 F_2 F_3	—	5.0 3.0 3.0	dB

3. Package Dimensions

Figure 3-1. Physical Dimensions 2N2919, 2N2919L, 2N2920, and 2N2920L (TO-78)



Symbol	Dimensions				Notes	
	Inches		Millimeters			
	Min.	Max.	Min.	Max.		
CD	0.335	0.370	8.51	9.40	—	
CD1	0.305	0.335	7.75	8.51	—	
CH	0.140	0.260	3.56	6.60	—	
HT	0.009	0.041	0.23	1.04	—	
LC	0.140	0.160	3.56	4.06	—	
LC1	0.200 TP		5.08 TP		9	
LD	0.016	0.021	0.041	0.53	10	
LL	See notes 10, 11 and 12					
LU	0.016	0.019	0.041	0.48	10	
L1	—	0.050	—	1.27	10	
L2	0.250	—	6.35	—	10	
P	0.100	—	2.54	—	8	
Q	—	0.050	—	1.27	7	
TL	0.029	0.045	0.74	1.14	5, 6	
TW	0.028	0.034	0.71	0.86	4, 5	
r	—	0.010	—	0.25	—	

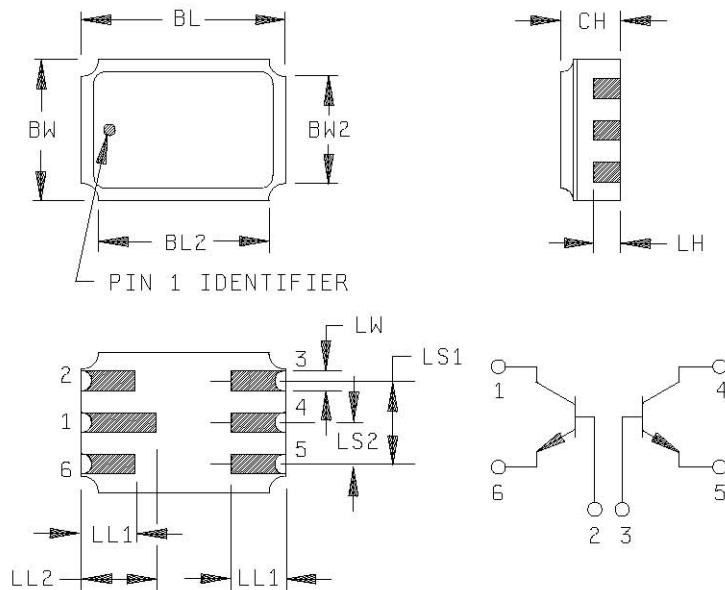
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Symbol	Dimensions				Notes	
	Inches		Millimeters			
	Min.	Max.	Min.	Max.		
a		45°TP		45°TP	9	

Notes:

1. Dimensions are in inches.
2. Millimeters are given for general information only.
3. Tab shown omitted.
4. Lead number 4 and 8 omitted on this variation.
5. Beyond r maximum, TW shall be held to a minimum length of 0.21 inch (5.33 mm).
6. TL shall be measured from maximum CD.
7. Details of outline in this zone are optional.
8. CD1 shall not vary more than 0.010 inch (0.25 mm) in zone P. This zone is controlled for automatic handling.
9. Leads at gauge plane 0.054 – 0.055 inch (1.37 – 1.40 mm) below seating plane shall be within 0.007 inch (0.18 mm) radius of true position (TP) at a maximum material condition (MMC) relative to the tab at MMC. The device may be measured by direct methods or by the gauge and gauging procedures described on gauge drawing GS-1.
10. LU applies between L1 and L2. LD applies between L2 and LL minimum. Diameter is uncontrolled in L1 and beyond LL minimum.
11. For transistor types 2N2919 and 2N2920, LL is 0.500 inch (12.70 mm) minimum and 0.750 inch (19.05 mm) maximum.
12. For transistor type 2N2919L and 2N2920L, LL is 1.500 inches (38.10 mm) minimum and 1.750 inches (44.45 mm) maximum.
13. In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.

Figure 3-2. Physical Dimensions (2N2919U and 2N2920U) Surface Mount



Symbol	Dimensions			
	Inches		Millimeters	
	Min.	Max.	Min.	Max.
BL	0.240	0.250	6.10	6.35
BL2	—	0.250	—	6.35
BW	0.165	0.175	4.19	4.44
BW2	—	0.175	—	4.44
CH	0.044	0.080	1.12	2.03
LH	0.026	0.039	0.66	0.99
LL1	0.060	0.070	1.52	1.78
LL2	0.082	0.098	2.08	2.49
LS1	0.095	0.105	2.41	2.67
LS2	0.045	0.055	1.14	1.39
LW	0.022	0.028	0.56	0.71

Pin No.	Transistor
1	Collector no. 1
2	Base no. 1
3	Base no. 2
4	Collector no. 2

.....continued

Pin No.	Transistor
5	Emitter no. 2
6	Emitter no. 1

Notes:

1. Dimensions are in inches.
2. Millimeters are given for general information only.
3. In accordance with AMSE Y14.5M, diameters are equivalent to φx symbology.

4. Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

Revision	Date	Description
A	06/2024	Document was converted to Microchip template. Previous Microsemi literature number T4-LDS-770706 was replaced with DS00005473A.

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ISBN: 978-1-6683-4787-4

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